Laboratory 15

Practical Advice for Microcontroller-based Design Projects

The project for the course is described in detail on the course website. Here is the direct link:

www.engr.colostate.edu/~dga/mech307/project.html

The purpose for this "laboratory" is to summarize many useful practical resources, considerations, and suggestions that might be helpful to you in designing and implementing your project. **Please read this material and apply the suggestions in your design**.

15.1 dc Power Supply Options for PIC Projects

There are a number of ways to provide the dc power required by the PIC and any ancillary digital integrated circuits. Actuators may also be powered by the same dc supply if their drive voltage match that of the digital circuitry, and if the current demands do not exceed the supply's capacity. We begin by assuming that TTL digital ICs are used in the project, requiring a closely regulated 5V dc source. If CMOS is used exclusively, there are fewer restrictions on the regulation of the dc voltage.

Figure 15.1 shows various low cost options for powering systems requiring a 5V supply. The options include:

- (1) a 6 V, 9 V, or 12 V wall transformer with a 5 V regulator
- (2) a potted power supply with ac input and 5 V regulated output
- (3) four AA batteries (6 V) in series with a 5 V regulator
- (4) a 9 V battery with a 5 V regulator
- (5) a rechargeable battery (or batteries in series) with a 5V regulator
- (6) a full featured instrumentation power supply

Other alternatives for powering projects include a computer power supply, or large batteries (e.g., car or motorcycle lead-acid batteries), especially if you have high current demands.

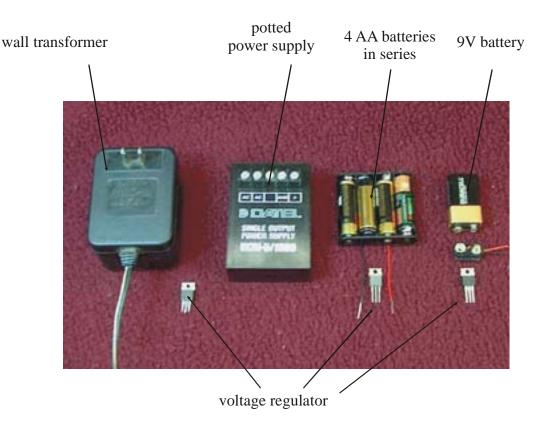


Figure 15.1 Low Cost Power Supply Options

A wall transformer (6 V, 9 V, or 12 V) will provide current at its rating, and must be used with a 5V regulator to control the level of the output voltage. Be sure that the current rating of the wall transformer exceeds the maximum current your circuit and actuators will draw. A potted power supply also has ac inputs and may provide one or more regulated dc outputs at its rated current. No voltage regulator is required if a 5V output is provided. Four AA batteries may be connected in series with the 6 V output regulated down to 5 V with a voltage regulator. A 9 V battery must also be connected to a 5 V regulator.

Battery power supply options provide portability for your design but may not be able to supply enough current. Section 15.2 presents more information on different types of batteries and their characteristics. Generally, actuators such as motors and solenoids as well as LED's can draw substantial current, and batteries should be tested before assuming that they will provide sufficient current. Digital circuitry, on the other hand, usually draws very little current.

Figure 15.2 shows an example of a full-featured instrumentation power supply. This particular model (HP 6235A) is a triple-output power supply, with 3 adjustable voltage outputs, each independently current rated. A full featured instrumentation power supply provides the easiest solution, but is expensive, heavy, and generally is not portable.



Figure 15.2 An Example of a Full-featured Instrumentation Power Supply

Except for the 5V potted supply and the adjustable instrumentation power supply, voltage regulators are required to convert the output voltage down to the 5V level. If your system is entirely CMOS, the regulation of the dc voltage is not required. Figure 15.3 illustrates a standard 7805 5V voltage regulator and shows how it is properly connected to your unregulated power supply output and your system. There must be a common ground from the power supply to your system. The mounting hole allows you to easily attach a heat sink to heat dissipate heat when necessary.

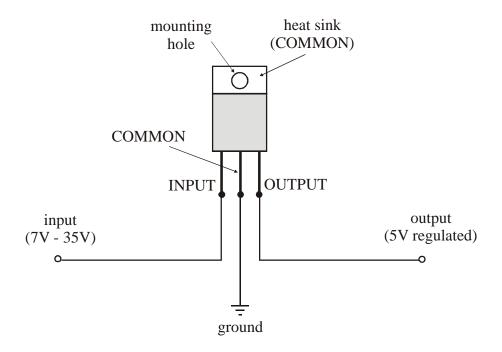


Figure 15.3 7805 Voltage Regulator Connections

When using a voltage regulator, one needs to be aware that if the voltage drop is large from the input to the output, and if significant current is drawn, the regulator will consume significant power and get very hot. A heat sink (and maybe a fan blowing on the heat sink) might be required to help dissipate this heat. If the voltage regulator gets too hot, it can be damaged. An alternative to dealing with the heat is to use a voltage source (or sources) better matched to the project needs, so the voltage regulator doesn't need to drop the voltage as much. Another good approach is to use different voltage sources for different voltage requirements. For example, use a source close to 5V to power your digital circuits, and use a different and dedicated source (and voltage regulator if necessary) to power devices (e.g., motors) that require different voltage levels. Another option is to use a voltage regulator or dc-to-dc converter that can drop the voltage more efficiently (e.g., a "switching" type instead of a "linear" type).

Table 15.1 provides a summary of how the various power supply options compare in terms of current ratings, size, and cost. Figure 15.4 shows an example specification sheet for an enclosed power supply. Before selecting or purchasing a supply for your design, it is important to first review the specifications, especially the current rating (2.5 A in this case).

Table 15.1 5V Power Supply Options Summary

Device	Typical current	Relative size	Relative cost
instrumentation power supply	1 A – 5 A	large	very expensive (~\$1000) but many features
small potted, open frame, or enclosed power supply	1 A – 10 A	medium	moderately expensive (~\$20-\$100)
wall transformer	1 A	small	cheap
9V battery	100 mA	small	cheap
4 AA batteries	100 mA	small	cheap
rechargeable battery	See Section 15.2	small	moderate



PWR SPLY,SW,16W,5VDC/2.5A,

Jameco #208952 Mfq Ref # PRK15U-0512W

16-Watt Switching Power Supply

Dual Outputs

◆ Output voltage: +5VDC @ 2.5A, +12VDC @ 0.7A

• Power: 16.0 Watts

• Input voltage: 120VAC @ 50-60Hz

• Size: 4.6"L x 3.2"W x 1.1"H

Mounting holes: 4.0"L x 2.5"W x 0.08"Dia.

Power density: 0.99W/in3

Load reg.: ±1.0%Line reg.: ±0.4%

Inrush current: 12A@120VAC
 Leakage current: 1.0mA@240V

Rise time 100ms
Hold-up time: 20ms
Vibration: 10-55Hz, 20G
Voltage ajustment: 5%

Eficiency: 64%Weight: 0.5 lbs.UL/CSA approved

Figure 15.4 Specifications for an Example Closed Frame Power Supply

15.2 Battery Characteristics

Many mechatronic designs will require dc voltage sources of some sort, usually tightly regulated, and often with high current capacities if actuators such as dc motors or solenoids are used. Here we present some of the important terms, considerations, and specifications in the proper selection of a battery as a power source.

The most important specification for a battery (besides its rated voltage) is the **amp-hour capacity.** It is defined as the current a battery can provide for one hour before it reaches its end-of-life point. The current that a battery can deliver is limited by its **equivalent series resistance**, which is the internal resistance that is in series with the "ideal voltage source" that is inside the battery. Batteries are composed of **cells**, the electro-chemical device that supplies the voltage and current. Cells may be combined in series or parallel within a battery for larger current and voltage capacities. The voltage of a cell will differ among the types of batteries due to their chemistry.

Primary cells are not rechargeable and are meant for one-time-use. Devices that are used infrequently or that require very low drain currents are good candidates for primary cells. **Secondary cells** are rechargeable, and their effectiveness may be replenished many times. Devices that require daily use with higher drain currents are good candidates for secondary cells.

The plot of the **battery discharge curve** is important in determining the stability of the voltage output. Figure 15.5 shows a typical shape for a discharge curve. One desires a broad plateau characteristic for the curve.

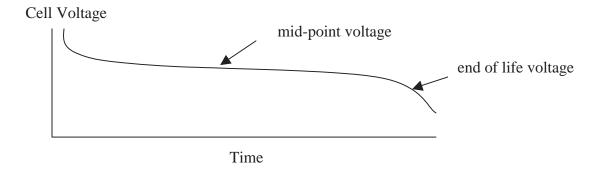


Figure 15.5 Example Battery Discharge Curve

The maximum current that a battery can deliver depends on the internal resistance of the battery. The load current times the internal resistance will result in a voltage drop reducing the effective voltage of the battery. Furthermore, there will be power dissipated by the internal resistance that, at high currents, may result in considerable heat production.

The salient factors a designer must consider in the selection of a power source for a mechatronic design are:

- o voltage required by the load
- o current required by the load

- o duty cycle of the system
- o cost
- o size and weight (specific energy)
- o need for rechargeability

As shown in Table 15.2, the chemistry of the cell will determine its open circuit voltage. High drain rate devices are good candidates for lead-acid and NiCd batteries. If a device is in storage most of the time, alkaline batteries are appropriate. Since batteries may be the heaviest component of a mechatronic design, the very light Li-ion and lithium-polymer chemistries may be good candidates. Lithium chemistries provide the highest energy per unit weight (specific energy) and per volume (energy density) of all types of batteries.

Rechargeable batteries will function well even after hundreds of cycles. Rechargeable batteries are significantly more expensive than primary cell batteries. Ni-MH batteries should be deep discharged several times when put into service for best performance. Ni-Cd batteries can suffer from an effect called "memory" where the battery capacity can diminish over time. It is caused by shallow charge cycles where the battery is only partially discharged and then fully charged repeatedly. You should give the battery a deep discharge from time to time for best performance.

<u>Table 15.2</u> Characteristics for Various Types of Batteries

Туре	Voltage (open circuit)	Туре	Typical Ah Capacity	R internal (Ω)
9V (heavy duty)	9 V	primary	0.30 @ 1 mA 0.15 @ 10 mA	35
9V alkaline	9 V	primary	0.60 @ 25 mA	2
9V lithium	9 V	primary	1.0 @ 25 mA 0.95 @ 80 mA	18
alkaline D	1.5 V	primary	17.1 @ 25 mA	0.1
alkaline C	1.5 V	primary	7.9 @ 25 mA	0.2
alkaline AA	1.5 V	primary	2.7 @ 25 mA	0.4
alkaline AAA	1.5 V	primary	1.2 @ 25 mA	0.6
BR-C PCMF-Li	3 V	primary	5.0 @ 5 mA	
CR-V3 Mn-Li	3 V	primary	3.0 @ 100 mA	
Ni-Cd D	1.3 V	secondary	4.0 @ 800 mA 3.5 @ 4 A	0.009
Ni-Cd 9V	8.1 V	secondary	0.1 @ 10 mA	0.84
Lead-acid D	2.0 V	secondary	2.5 @ 25 mA 2.0 @ 1 A	0.006
Ni-MH AAA	1.2 V	secondary	0.55 @ 200 mA	
Ni-MH AA	1.2 V	secondary	1.3 @ 200 mA	
Ni-MH C	1.2 V	secondary	3.5 @ 200 mA	
Ni-MH D	1.2 V	secondary	7.0 @ 200 mA	
Ni-MH 9V	8.4 V	secondary	0.13 @ 200 mA	
ML2430 Mn-Li	3 V	secondary	0.12 @ 300 mA	
Lithium Ion	3.7 V	secondary	0.76 @ 200 mA	

15.3 Relays and Power Transistors

Actuators often require large currents at voltages different from the control circuit. Control signals are interfaced to actuator and other large current devices using relays or power transistors.

When a circuit must be completely on or off with minimal on-state voltage drop, the electromagnetic (EMR) is the only suitable choice. Solid state relays (SSRs) are the most durable and reliable but are never completely on or off and can have substantial on-state voltage drops with associated heat generation. Relays can switch dc or ac power.

Power transistors switch currents extremely fast and with less electromagnetic interference than EMRs. Power bipolar junction transistors (BJTs) and field effect transistors (FETs) can be used to switch dc power. FETs are easier to implement in a design because they do not require voltage biasing at the input. ac power cannot be switched with BJTs or FETs. Silicon controlled rectifiers (SCRs) and TRIACS are solid state devices that can switch ac power. Voltage and current capacities are important criteria when selecting any of these devices.

Here is a summary of the pros and cons of relays and transistors:

Transistors:

- can switch much faster than relays.
- produce less electromagnetic interference.
- last longer than most relays.
- can be used as current amplifiers where the output current can vary with the input voltage.

Relays:

- provide electrical isolation between the signal circuit and power circuit so the control circuitry is unaffected by the power circuit.
- can switch larger currents in general.
- do not require voltage biasing at the input.
- have minimal on-state resistance and maximum off-state resistance.
- can switch dc or ac power.

15.4 Soldering

Once a prototype circuit has been tested on a breadboard, a permanent prototype can be created by soldering components and connections using a protoboard (also called a perf board, perforated board, or vector board). These boards are manufactured with a regular square matrix of holes spaced 0.1 in apart as with the insertion points in a breadboard. Unlike with the breadboard, there are no pre-wired connections between the holes. All connections must be completed with external wire and solder joints. The result is a prototype that is more robust, and that can be used in a prototype mechatronic system. You should consider this method for your class project.

For multiple versions of a prototype or production version of a circuit, a printed circuit board (PCB) is manufactured. Here, components are inserted and soldered to perforations in the board and all connections between the components are "printed" with a conducting medium. We do not support facilities to produce PCBs, but they are common in manufacturing environments.

Solder is a metallic alloy of tin, lead and other elements that has a low melting point (approximately 375°F). The solder usually is supplied in wire form often with a flux core, that facilitates melting and wetting of metallic surfaces. The solder is applied to wire and electronic components using a soldering iron consisting of a heated tip and support handle (see Figure 15.6). Sometimes you can also select the temperature of the tip using a rheostat. When using the soldering iron, be sure the tip is securely installed. Then after heating be sure the tip is clean and shiny. If not briefly wipe it on a wet sponge.

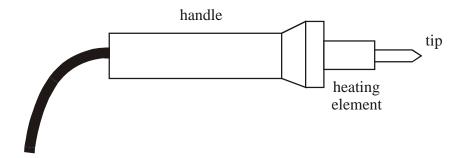
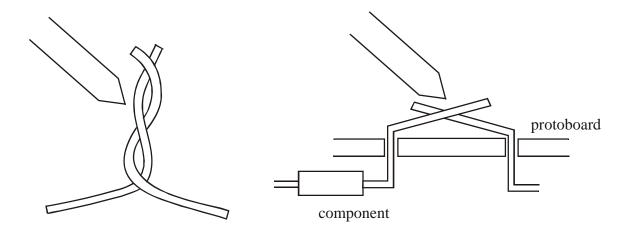


Figure 15.6 Soldering Iron

Steps in creating a good solder connection:

- (1) Before soldering, assemble your materials: a hot soldering iron, solder, components, wire, protoboard or perforated board, wet sponge and magnifying glass.
- (2) Clean any surfaces that are to be joined. You may use fine emery paper or a metal brush to remove oxide layers and dirt so that the solder may easily wet the surface. Rosin core (flux) solder will enhance the wetting process.
- (3) Make a mechanical contact between elements to be joined, either by bending or twisting, and ensure that they are secure so that they will not move when you apply the iron. Figure 15.7 illustrates two wires twisted together and a component inserted in a protoboard in preparation for soldering.



- (a) wire twisted together
- (b) bent leads through protoboard holes

Figure 15.7 Preparing a Soldered Joint

- (4) Heating the elements to be joined is necessary so that the solder properly wets both elements and a strong bond results. When using electronic components, practice in heating is necessary so that the process is swift enough not to thermally damage the silicon device. Soldering irons with sharper tips are convenient for joining small electronic components, since they can deliver the heat very locally.
- (5) When the work has been heated momentarily, apply the solder to the work (not the soldering iron) and it should flow fluidly over the surfaces. Feed enough solder to provide a robust but not blobby joint. (If the solder balls up on the iron the work is not hot enough.) Smoothly remove the iron and allow the joint to solidify momentarily. You should see a slight change in surface texture of the solder when it solidifies. If the joint is ragged or dull you may have a cold joint, one where the solder has not properly wetted the elements. Such a joint will create problems in conductivity and must be repaired by resoldering. Figure 15.8 illustrates a successful solder joint where the solder has wet both surfaces, in this case a component lead in a metal hole perforated board.

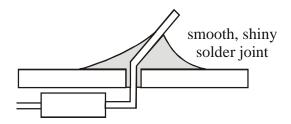


Figure 15.8 A Successful Solder Joint

(6) If flux solvent is available, wipe the joint clean.

(7) Inspect your work with a magnifying glass to see that the joint has been properly made.

Often you may have a small component or integrated circuit (IC) that you do not want to heat excessively. To avoid excessive heat with a small component, you may use a heat sink. A heat sink is a piece of metal like an alligator clip connected to the wire between the component and the connection to help absorb some of the heat that would be conducted to the component. However if the heat sink is too close to the connection it will be hard to heat the wires. When using an IC, a socket can be soldered into the protoboard first, and then the IC inserted, thereby avoiding any thermal stress on the IC.

When using hook-up wire, be sure to use solid wire on a protoboard since it will be easy to manipulate and join. Wire must be stripped of its insulating cover before soldering. When using hook-up wire in a circuit, tinning the wire first (covering the end with a thin layer of solder) facilitates the joining process.

Often you may make mistakes in attaching components and need to remove one or more soldered joints. A solder sucker makes this a lot easier. To use a solder sucker (see Figure 15.9), cock it first, heat the joint with the soldering iron, then trigger the solder sucker to remove the molten solder. Then the components can easily be removed since very little solder will be left to hold them.

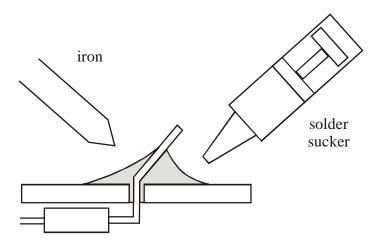


Figure 15.9 Removing a Soldered Joint

15.5 Other Practical Considerations

For basic prototype circuit assembly and troubleshooting advice, see Section 2.3 in Lab 2 and Section 7.4 in Lab 7. For advice for debugging circuits with PIC microcontrollers, see Section 10.4 in Lab 10.

Here are some other practical suggestions for microcontroller-based designs:

General Electrical Design Suggestions:

- When ordering ICs, make sure you specify **DIP** (dual in-line packages) and not surface mount packages (e.g., SOP). DIP chips are well suited to use in breadboards and protoboards. Surface mount ICs require printed circuit boards (PCBs) and special soldering equipment.
- Make sure your power supply (or supplies) can provide adequate current for the entire
 design. If necessary, use separate power supplies for your signal and power circuits.
- Use **breadboards** with caution and care because connections can be unreliable, and the base plate adds capacitance to your circuits. Hard-wired and soldered protoboards or printed circuit boards (PCBs) can be much more reliable. See Section 15.4 for advice on how to solder properly. Be sure to use sockets for all ICs to prevent damage during soldering and to allow easy replacement of the ICs. Also, if you have a working breadboard circuit, it is advisable to use duplicate components (where possible) for the soldered board (i.e., don't cannibalize components from a working prototype circuit in case something goes wrong or gets damaged when soldering your board).
- Use a **storage capacitor** (e.g., 100 μF or bigger) across the main power and ground lines of a power supply that does not have built-in output capacitance (e.g., batteries, wall transformers, and regulated voltages) to minimize voltage swings during output current spikes. Also, use **bypass capacitors** (e.g., 0.1 μF) across the power and grounds lines of all individual ICs to suppress any current and voltage spikes.
- Make sure all components and sources have a common ground unless using relays, wireless interfaces, or opto-isolators, in which case you should keep the independent power supply grounds separate.
- Avoid grounding problems and electromagnetic interference (EMI). Section 2.10
 in the textbook presents various methods to reduce EMI, specifically using optoisolators, single point grounding, ground planes, coaxial or twisted pair cables, and
 bypass capacitors.
- Don't leave **IC pins floating** (especially with CMOS devices). In other words, connect all used and functional pins to signals or power or ground. As an example, do not assume that leaving a microcontroller's reset pin disconnected will keep a microcontroller from resetting itself. You should connect the reset pin to 5V for an active-low reset or ground for an active-high reset, and not leave the pin floating where its state can be uncertain.
- Be aware of possible **switch bounce** in your digital circuits and add debounce circuits

- or software to eliminate the bounce.
- Use **flyback diodes** on motors, solenoids, relay coils, and other high inductance devices that are being switched.
- Use **buffers**, line drivers, and inverters where current demand is large for a digital output.
- Use **Schmitt triggers** on all noisy digital sensor outputs (e.g., a Hall-effect proximity sensor or photo-interrupter).
- Use a **common-emitter** configuration with transistors (i.e., put the load on the high side) to avoid voltage biasing difficulties.
- Be careful to identify and properly interface any **open-collector** or open-drain outputs on digital ICs (e.g., pin RA4 on the PIC).
- For reversible dc motors, use "off-the-shelf" commercially available **H-bridge** drivers (e.g., National Semiconductor's LMD 18200) instead of building your own.

PIC-related Suggestions (see more in Section 10.4 of Lab 10):

- Follow the microcontroller design procedure in Section 7.9 of the textbook.
- Modularize your software and independently develop and test each module (i.e., don't write the entire program at once expecting it to work).
- Use LEDs to indicate status and location within your program when it is running, and to indicate input and output states.
- Be aware of the different characteristics of the I/O pins on the PIC. Refer to Figures 7.15 and 7.16 in the textbook to see how to properly interface to the different pins for different purposes.
- Be aware that PicBasic Pro commands totally occupy the processor while they are running (e.g., the line after a SOUND command is not reached or processed until the SOUND command has terminated).
- Refer to Design Example 7.1 in the textbook for ideas on how to interface to 7-segment digital displays with a minimum number of pins.
- When prototyping with a soldered protoboard or printed circuit board, use IC sockets
 to allow easy installation and removal of the PICs without damaging pins. Also, always
 use a "chip puller" tool to remove ICs (e.g., PICs) from breadboards or soldered IC
 sockets.